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# N- and P-Channel Enhancement-Mode MOSFET Pair

#### **Features**

- ► Integrated GATE-to-SOURCE resistor
- ► Integrated GATE-to-SOURCE Zener diode
- Low threshold
- ► Low on-resistance
- ▶ Low input capacitance
- ▶ Fast switching speeds
- ► Free from secondary breakdown
- Low input and output leakage
- Independent, electrically isolated N- and P-channels

### **Applications**

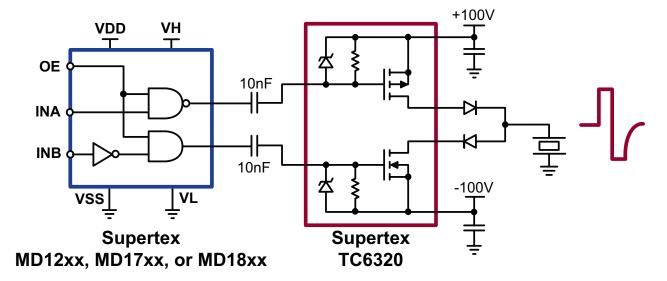
- ► High voltage pulsers
- Amplifiers
- Buffers
- Piezoelectric transducer drivers
- ► General purpose line drivers
- ► Logic level interfaces

### **General Description**

The Supertex TC6320 consists of high voltage, low threshold N-channel and P-channel MOSFETs in 8-Lead SOIC and DFN packages. Both MOSFETs have integrated GATE-to-SOURCE resistors and GATE-to-SOURCE Zener diode clamps which are desired for high voltage pulser applications. It is a complimentary, high-speed, high voltage, GATE-clamped N- and P-channel MOSFET pair, which utilizes an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

## **Typical Application Circuit**



## **Ordering Information**

Part Number	Package Option	Packing
TC6320K6-G	8-Lead DFN (4x4)	3000/Reel
TC6320TG-G	8-Lead SOIC	2000/Reel

<sup>-</sup>G indicates package is RoHS compliant ('Green')



## **Absolute Maximum Ratings**

Parameter	Value
DRAIN-to-SOURCE voltage	BV <sub>DSS</sub>
DRAIN-to-GATE voltage	BV <sub>DGS</sub>
Operating and storage temperature	-55°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

### **Typical Thermal Resistance**

Package	$\theta_{ja}$
8-Lead DFN	44°C/W
8-Lead SOIC	101°C/W

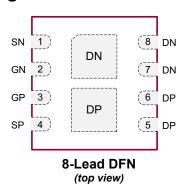
#### Note:

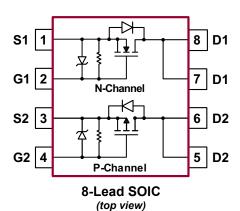
1.0oz, 4-layer, 3"x4" PCB

### **Product Summary**

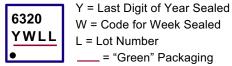
BV <sub>DSS</sub> /(	/BV <sub>DGS</sub> /)	$R_{DS(ON)} \ (max) \ (\mathfrak{Q})$				
N-Channel	P-Channel	N-Channel	P-Channel			
200	-200	7.0	8.0			

## **Pin Configurations**



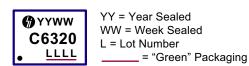


## **Package Marking**



Package may or may not include the following marks: Si or

8-Lead DFN



Package may or may not include the following marks: Si or 🎧

8-Lead SOIC

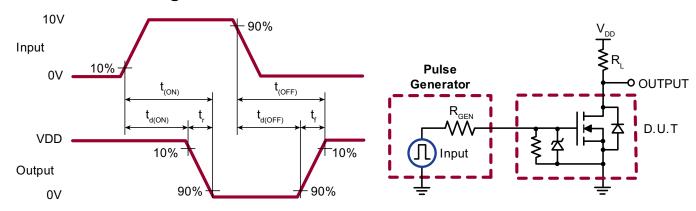
# N-Channel Electrical Characteristics ( $T_c$ = 25°C unless otherwise specified)

Sym	Parameter	Min	Тур	Max	Units	Conditions
BV <sub>DSS</sub>	DRAIN-to-SOURCE breakdown voltage	200	-	_	V	$V_{GS} = 0V, I_D = 2.0mA$
V <sub>GS(th)</sub>	GATE threshold voltage	1.0	-	2.0	V	$V_{GS} = V_{DS}$ , $I_D = 1.0 \text{mA}$
$\Delta V_{GS(th)}$	Change in V <sub>GS(th)</sub> with temperature	-	-	-4.5	mV/°C	$V_{GS} = V_{DS}$ , $I_D = 1.0 \text{mA}$
R <sub>gs</sub>	GATE-to-SOURCE shunt resistor	10	-	50	kΩ	I <sub>GS</sub> = 100μA
VZ <sub>GS</sub>	GATE-to-SOURCE Zener voltage	13.2	-	25	V	I <sub>GS</sub> = 2.0mA
		-	-	10.0	μA	$V_{DS}$ = Max rating, $V_{GS}$ = 0V
I <sub>DSS</sub>	Zero GATE voltage DRAIN current	-	-	1.0	mA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0V$ , $T_A = 125^{\circ}C$
	On otata DDAIN ourrant	1.0	-	-	^	$V_{GS} = 4.5V, V_{DS} = 25V$
I <sub>D(ON)</sub>	On-state DRAIN current	2.0	-	-	A	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 25V
В	Static DRAIN-to-SOURCE on-state	-	-	8.0		$V_{GS} = 4.5V, I_{D} = 150mA$
$R_{DS(ON)}$	resistance	-	-	7.0	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.0A
$\Delta R_{DS(ON)}$	Change in R <sub>DS(ON)</sub> with temperature	-	-	1.0	%/°C	V <sub>GS</sub> = 4.5V, I <sub>D</sub> =150mA
G <sub>FS</sub>	Forward transconductance	400	-	-	mmho	$V_{DS} = 25V, I_{D} = 500mA$
C <sub>ISS</sub>	Input capacitance	-	-	110		V <sub>GS</sub> = 0V,
C <sub>oss</sub>	Common SOURCE output capacitance	-	-	60	pF	$V_{DS} = 25V$ ,
C <sub>RSS</sub>	Reverse transfer capacitance	-	-	23		f = 1.0MHz
t <sub>d(ON)</sub>	Turn-on delay time	-	-	10		
t <sub>r</sub>	Rise time	-	-	15		V <sub>DD</sub> =25V,
t <sub>d(OFF)</sub>	Turn-off delay time	-	-	20	ns	$I_D = 1.0A,$ $R_{GEN} = 25\Omega$
t,	Fall time	-	-	15		OLIV .
V <sub>SD</sub>	Diode forward voltage drop	-	-	1.8	V	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 500mA
t <sub>rr</sub>	Reverse recovery time	-	300	-	ns	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 500mA

### Notes:

- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

## **N-Channel Switching Waveforms and Test Circuit**



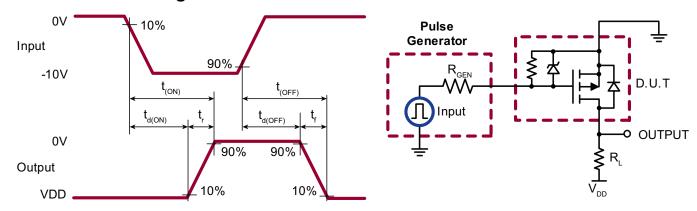
## P-Channel Electrical Characteristics (T<sub>c</sub> = 25°C unless otherwise specified)

Sym	Parameter	Min	Тур	Max	Units	Conditions		
BV <sub>DSS</sub>	DRAIN-to-SOURCE breakdown voltage	-200	-	-	V	$V_{GS} = 0V, I_{D} = -2.0 \text{mA}$		
V <sub>GS(th)</sub>	GATE threshold voltage	-1.0	-	-2.4	V	$V_{GS} = V_{DS}$ , $I_{D} = -1.0$ mA		
$\Delta V_{GS(th)}$	Change in V <sub>GS(th)</sub> with temperature	-	-	4.5	mV/°C	$V_{GS} = V_{DS}$ , $I_{D} = -1.0$ mA		
R <sub>gs</sub>	GATE-to-SOURCE shunt resistor	10	-	50	kΩ	I <sub>GS</sub> = 100μA		
VZ <sub>GS</sub>	GATE-to-SOURCE Zener voltage	13.2	-	25	V	I <sub>GS</sub> = -2mA		
		-	-	-10	μA	$V_{DS}$ = Max rating, $V_{GS}$ = 0V		
l <sub>DSS</sub>	Zero GATE voltage DRAIN current	-	-	-1.0	mA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0V$ , $T_A = 125^{\circ}C$		
ı	On state DDAIN surrent	-1.0	-	-	^	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -25V		
I <sub>D(ON)</sub>	On-state DRAIN current	-2.0	-	-	A	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -25V		
Ь	Static DRAIN-to-SOURCE on-state resis-	-	-	10	0	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -150mA		
$R_{DS(ON)}$	tance	-	-	8.0	Ω	V <sub>GS</sub> = -10V, I <sub>D</sub> = -1.0A		
$\Delta R_{DS(ON)}$	Change in R <sub>DS(ON)</sub> with temperature	-	-	1.0	%/°C	V <sub>GS</sub> = -10V, I <sub>D</sub> =-200mA		
G <sub>FS</sub>	Forward transconductance	400	-	-	mmho	V <sub>DS</sub> = -25V, I <sub>D</sub> = -500mA		
C <sub>ISS</sub>	Input capacitance	-	-	200		V <sub>GS</sub> = 0V,		
C <sub>oss</sub>	Common SOURCE output capacitance	-	-	55	pF	$V_{DS} = -25V,$		
C <sub>RSS</sub>	Reverse transfer capacitance	-	-	30		f = 1.0MHz		
t <sub>d(ON)</sub>	Turn-on delay time	-	-	10				
t <sub>r</sub>	Rise time	-	-	15		V <sub>DD</sub> = -25V,		
t <sub>d(OFF)</sub>	Turn-off delay time	-	-	20	ns	$I_D = -1.0A,$ $R_{GEN} = 25\Omega$		
t <sub>f</sub>	Fall time	-	-	15		GEN		
V <sub>SD</sub>	Diode forward voltage drop	-	-	-1.8	V	V <sub>GS</sub> = 0V, I <sub>SD</sub> = -500mA		
t <sub>rr</sub>	Reverse recovery time	-	300	-	ns	V <sub>GS</sub> = 0V, I <sub>SD</sub> = -500mA		

### Notes:

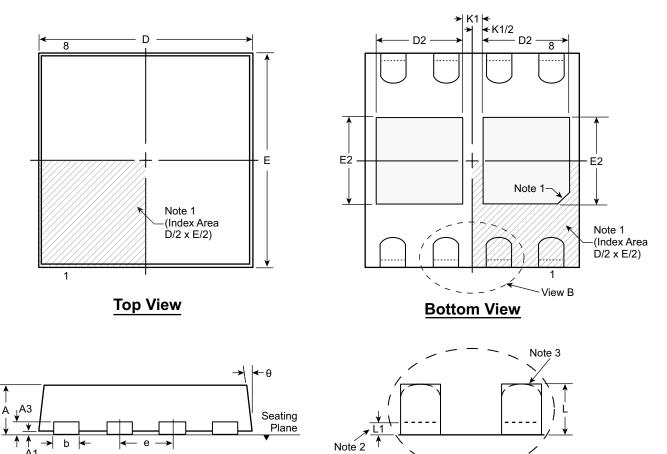
- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

## P-Channel Switching Waveforms and Test Circuit



# 8-Lead DFN Package Outline (K6)

## 4.00x4.00mm body, 1.00mm height (max), 1.00mm pitch (dual pad)



#### Notes:

 A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

View B

- 2. Depending on the method of manufacturing, a maximum of 0.15mm pullback (L1) may be present.
- 3. The inner tip of the lead may be either rounded or square.

Side View

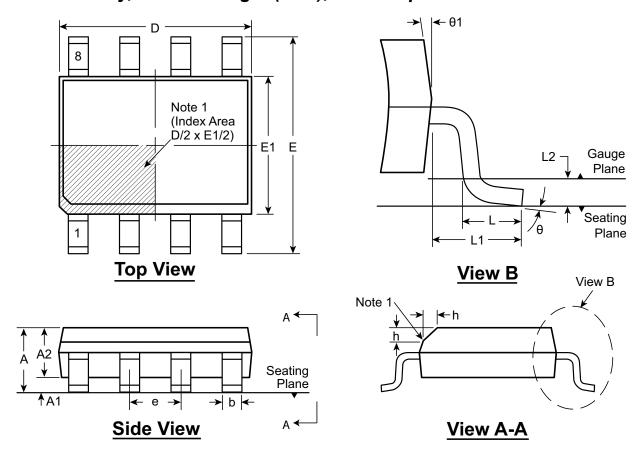
Symbo	ol	Α	A1	А3	b	D	D2	E	E2	е	K1	L	L1	θ	
	MIN	0.80	0.00		0.25	3.90	1.35	3.90	1.35			0.40	0.00	0°	
Dimension (mm)	NOM	0.90	-	0.20 REF	0.30	4.00	1.45	4.00	1.45	1.00 BSC	0.50 REF	0.50	-	-	
(11111)	MAX	1.00	0.05		0.35	4.10	1.55	4.10	1.55				0.60	0.15	14º

Drawings not to scale

Supertex Doc. #: DSPD-8DFNK64x4P100, Version C010813

# 8-Lead SOIC (Narrow Body) Package Outline (TG)

4.90x3.90mm body, 1.75mm height (max), 1.27mm pitch



#### Note:

1. This chamfer feature is optional. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbo		Α	<b>A</b> 1	A2	b	D	Е	E1	е	h	L	L1	L2	θ	θ1
Dimension (mm)	MIN	1.35*	0.10	1.25	0.31	4.80*	5.80*	3.80*	1.27 BSC -	0.25	0.40			<b>0</b> o	<b>5</b> °
	NOM	-	-	-	-	4.90	6.00	3.90		-	1.04 REF	0.25 BSC	-	-	
	MAX	1.75	0.25	1.65*	0.51	5.00*	6.20*	4.00*		0.50	1.27		200	<b>8</b> º	15°

JEDEC Registration MS-012, Variation AA, Issue E, Sept. 2005.

Drawings are not to scale.

Supertex Doc. #: DSPD-8SOLGTG, Version I041309.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="http://www.supertex.com/packaging.html">http://www.supertex.com/packaging.html</a>.)

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<sup>\*</sup> This dimension is not specified in the JEDEC drawing.